General Description

The SJS2309A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

Features

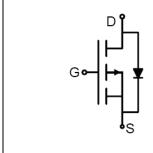
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

| Parameter | Value | Unit |
|-------------------------|-------|------|
| V _{DS} | -60 | ٧ |
| R _{DS(ON)_TYP} | 121 | mΩ |
| I _D | -2.5 | А |
| Q _G | 10 | nC |







Schematic Diagram

SOT-23 top view

Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|---------|---------|---------|-----------|------------|----------|
| SJS2309 | 2309 | SOT-23 | Tape | \ | \ | 3000 Pcs |

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

| Symbol | Parameter | Limit | Unit | |
|----------------------------------------------------------------|---------------------------------------------------|------------|------|--|
| V _{DS} | Drain-Source Voltage (V _{GS} =0V) | -60 | V | |
| V_{GS} | Gate-Source Voltage (V _{DS} =0V) ±20 | | V | |
| 1- | Drain Current-Continuous(T _A =25°C) | -2.5 | А | |
| I _D Drain Current-Continuous(T _A =100°C) | | -1.5 | А | |
| IDM (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | -10 | А | |
| D | Maximum Power Dissipation(T _A =25°C) | 1.8 | W | |
| P _D | Maximum Power Dissipation(T _A =100°C) | 0.7 | W | |
| Eas | Avalanche energy (Note 2) | 30 | mJ | |
| TJ, TSTG | Operating Junction and Storage Temperature Range | -55 To 150 | °C | |

Table 2. Thermal Characteristic

| Symbol | Parameter | Тур | Max | Unit |
|--------|----------------------------------------------------------|-----|-----|------|
| RθJA | R _{0JA} Thermal Resistance, Junction-to-Ambient | | 73 | °C/W |



Table 3. Electrical Characteristics ($T_J=25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---------------------------------------------------------------------|------|-----|------|------|
| On/Off States | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =-250μA | -60 | | | V |
| | | V _{DS} =-60V, V _{GS} =0V T _J =25°C | | | -1 | μΑ |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =-60V, V _{GS} =0V T _J =125°C | | | -100 | μΑ |
| Igss | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =-250µA | -2.5 | | -1 | V |
| g FS | Forward Transconductance | V _{DS} =-5V, I _D =-1.5A | | 4.3 | | S |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =-10V, I _D =-1.5A T _J =25℃ | | 121 | 157 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =-4.5V, I _D =-1A T _J =25°C | | 137 | 182 | mΩ |
| Dynamic Chara | cteristics | , | | • | | |
| Ciss | Input Capacitance | | | 971 | | pF |
| Coss | Output Capacitance | V _{DS} =-30V,V _{GS} =0V, f=1.0MHz | | 418 | | pF |
| Crss | Reverse Transfer Capacitance | | | 338 | | pF |
| Rg | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1.0MHz | | 9.9 | | Ω |
| Switching Para | meters | | | | | • |
| t _{d(on)} | Turn-on Delay Time | | | 7 | | nS |
| t _r | Turn-on Rise Time | V _{GS} =-10V, V _{DS} =-30V, | | 20 | | nS |
| $t_{d(off)}$ | Turn-Off Delay Time | R _L =20Ω, R _{GEN} =3Ω | | 16 | | nS |
| t _f | Turn-Off Fall Time | | | 24 | | nS |
| Qg | Total Gate Charge | | | 10 | | nC |
| Q_{gs} | Gate-Source Charge | V _{GS} =-10V, V _{DS} =-30V, I _D =-1.5A | | 2 | | nC |
| Q_gd | Gate-Drain Charge | | | 1.6 | | nC |
| Source-Drain D | iode Characteristics | | | | | • |
| I _{SD} | Source-Drain Current (Body Diode) | | | | -2.5 | Α |
| V _{SD} | Forward on Voltage (Note 3) | V _{GS} =0V, I _S =-1.5A | | | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I==-1.5A, dI/dt=100A/μs | | 12 | | ns |
| Qrr | Reverse Recovery Charge | I _F =-1.5A, dI/dt=100A/μs | | 6 | | nC |

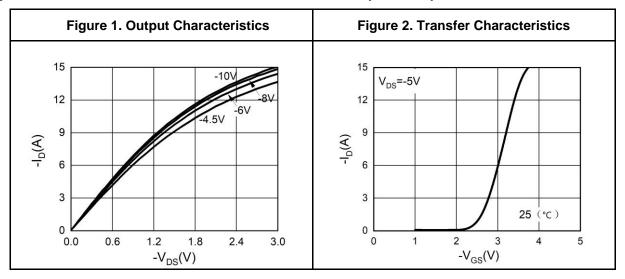
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

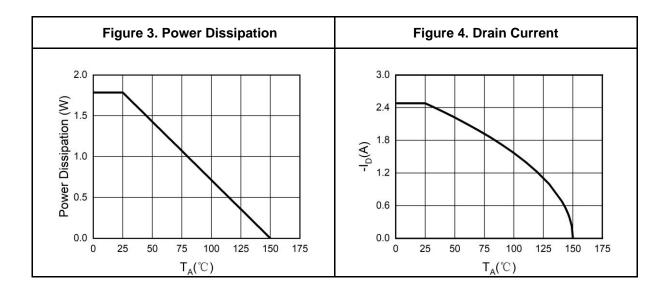
Notes 2.E_{AS} condition: T_J =25 $^{\circ}$ C, V_{DD} =-40V, V_G =10V, Rg=25 Ω , L=0.5mH.

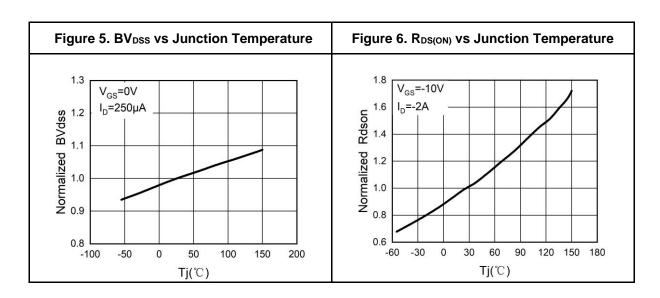
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Typical Electrical And Thermal Characteristics (Curves)

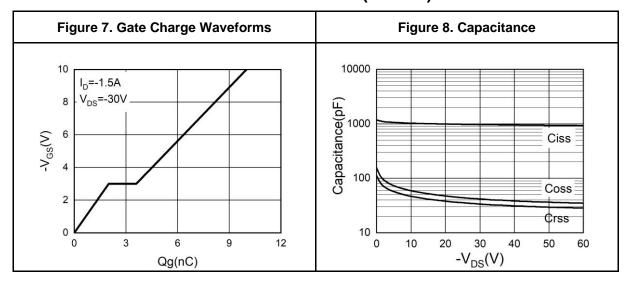


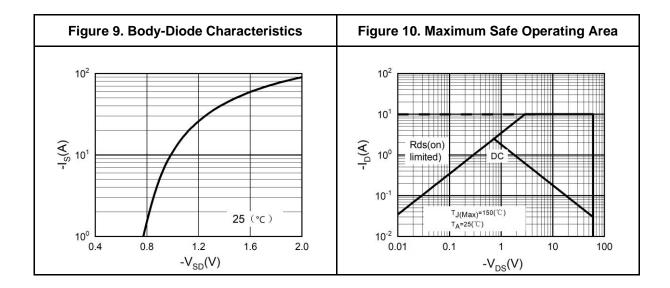






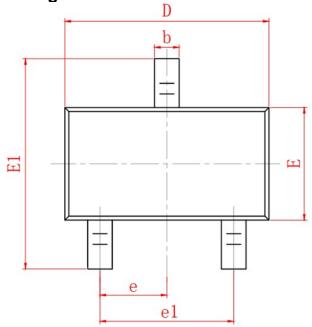
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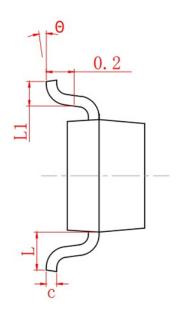


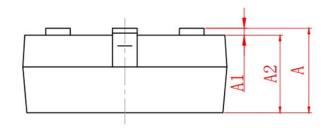




SOT-23 Package Information







| SYMBOL | MIN | NOM | MAX | |
|--------|----------|------|------|--|
| А | 0.90 | 1.05 | 1.20 | |
| A1 | 0.00 | 0.05 | 0.10 | |
| A2 | 0.90 | 1.00 | 1.10 | |
| b | 0.30 | 0.40 | 0.50 | |
| С | 0.08 | 0.10 | 0.15 | |
| D | 2.80 | 2.90 | 3.00 | |
| Е | 1.20 | 1.30 | 1.40 | |
| E1 | 2.30 | 2.40 | 2.50 | |
| L | 0.30 | 0.40 | 0.50 | |
| θ | 0° | 5° | 10° | |
| L1 | 0.55 REF | | | |
| е | 0.95 BSC | | | |
| e1 | 1.90 REF | | | |



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